COMPLIANT

HALOGEN FREE

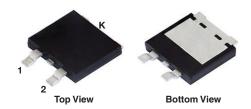


# Vishay General Semiconductor

# Dual High-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.5 \text{ V}$  at  $I_F = 2.5 \text{ A}$ 

# eSMP<sup>®</sup> Series SMPD (TO-263AC)





### **DESIGN SUPPORT TOOLS AVAILABLE**



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	2 x 5 A		
$V_{RRM}$	100 V		
I <sub>FSM</sub>	80 A		
$V_F$ at $I_F = 5$ A $(T_A = 125  ^{\circ}\text{C})$	0.62 V		
T <sub>J</sub> max.	175 °C		
Package	SMPD (TO-263AC)		
Circuit configuration	Common cathode		

### **FEATURES**

- Trench MOS Schottky technology
- Very low profile typical height of 1.7 mm
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available:
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

### TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

## **MECHANICAL DATA**

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V10DM100C	UNIT	
Device marking code			V10DM100C		
Maximum repetitive peak reverse voltage		V <sub>RRM</sub>	100	V	
Maximum average forward rectified current (fig. 1)	per device	I <sub>F(AV)</sub> (1)	10	^	
	per diode		5	Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	80	А	
Operating junction temperature range		T <sub>J</sub> <sup>(2)</sup>	-40 to +175	°C	
Storage temperature range		T <sub>STG</sub>	-55 to +175	- °C	

### Notes

<sup>(1)</sup> Mounted on infinite heatsink

 $<sup>^{(2)}</sup>$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$ 



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage per diode	I <sub>F</sub> = 2.5 A	$I_F = 2.5 \text{ A}$ $I_F = 5 \text{ A}$ $I_A = 25 \text{ °C}$	V <sub>F</sub> <sup>(1)</sup>	0.58	-	V
	I <sub>F</sub> = 5 A			0.71	0.79	
	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 125 °C		0.50	-	
	I <sub>F</sub> = 5 A			0.62	0.70	
Reverse current at rated V <sub>R</sub> per diode	V <sub>R</sub> = 70 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	0.01	-	mA
		T <sub>A</sub> = 125 °C		0.70	-	
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 25 °C		-	0.1	
	v <sub>R</sub> = 100 v	T <sub>A</sub> = 125 °C		1.4	4.0	
Typical junction capacitance	4.0 V, 1 MHz		CJ	480	-	pF

### Notes

 $^{(1)}$  Pulse test: 300  $\mu$ s pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq 5 \text{ ms}$ 

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V10DM100C	UNIT	
Typical thermal resistance per device	R <sub>0</sub> JC <sup>(1)</sup>	2.5	°C/W	
	R <sub>0</sub> JA (2)(3)	58	C/VV	

### Notes

- (1) Mounted on infinite heatsink
- $^{(2)} \ \ The \ heat \ generated \ must \ be \ less \ than \ the \ thermal \ conductivity \ from \ junction-to-ambient: \ dP_D/dT_J < 1/R_{\theta JA} \ \ junction-to-ambient$
- (3) Free air, without heatsink

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V10DM100C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel	
V10DM100CHM3/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel	

### Note

(1) AEC-Q101 qualified



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# **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

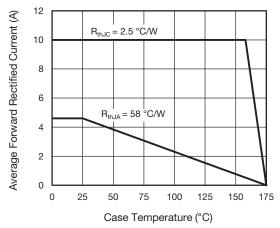


Fig. 1 - Maximum Forward Current Derating Curve

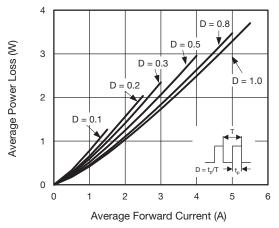


Fig. 2 - Average Power Loss Characteristics

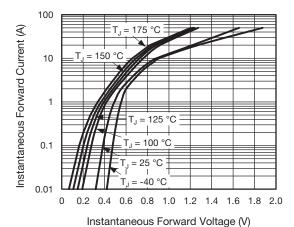


Fig. 3 - Typical Instantaneous Forward Characteristics

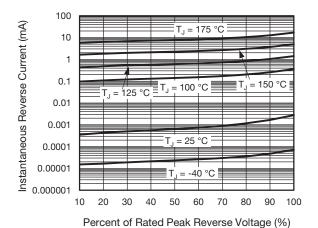


Fig. 4 - Typical Reverse Leakage Characteristics

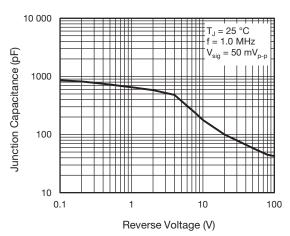


Fig. 5 - Typical Junction Capacitance

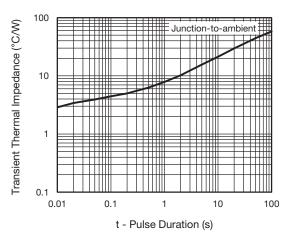


Fig. 6 - Typical Transient Thermal Impedance



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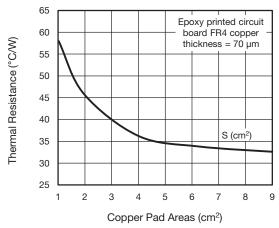


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### SMPD (TO-263AC) 0.402 (10.20) 0.071 (1.80) 0.063 (1.60) 0.386 (9.80) 0.020 (0.52) 0.011 (0.27) -0.059 (1.50) REF. 0.048 (1.21) 0.032 (0.81) 0.354 (8.99) 0.338 (8.59) 0.509 (12.93) 0.485 (12.33) 0 to 0.01 (0 to 0.254) 0.069 (1.74) 0.053 (1.34) 0.063 (1.60) 0.020 (0.52) 0.047 (1.20) 0.011 (0.27) 0.052 (1.23) 0.028 (0.72)

# Mounting Pad Layout 0.339 (8.60) 0.323 (8.20) 0.194 NOM. 0.194 NOM. 0.604 (15.33) 0.525 (13.33) 0.080 (2.03) MIN. 0.105 (2.67) 0.095 (2.41)



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